

## N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub>	100	V		
$R_{DS(on)}$ $V_{GS} = 10$ V	32	mΩ		
I <sub>D</sub>	9	А		
Configuration	Single			

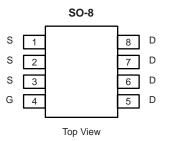
#### **FEATURES**

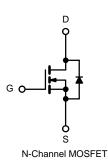
- Halogen-free According to IEC 61249-2-21 Definition
- Extremely Low Q<sub>gd</sub> for Switching Losses
- 100 % Rg Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC

- 55 to 150

#### **APPLICATIONS**

• Primary Side Switch





<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)								
Parameter		Symbol	Limit	Unit				
Drain-Source Voltage		V <sub>DS</sub>	100	V				
Gate-Source Voltage		V <sub>GS</sub>	± 20	v				
	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	9					
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C		6					
	T <sub>A</sub> = 25 °C		6 <sup>b, c</sup>					
	T <sub>A</sub> = 70 °C		5 <sup>b, c</sup>	A				
Pulsed Drain Current		I <sub>DM</sub>	40					
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		7					
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	3.8 <sup>b, c</sup>					
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	30					
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	112	mJ				
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		14					
	T <sub>C</sub> = 70 °C	P <sub>D</sub>	5	W				
	T <sub>A</sub> = 25 °C	'D	4 <sup>b, c</sup>	vv				
	T <sub>A</sub> = 70 °C	1	2 <sup>b, c</sup>					

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	33	40	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	17	21	0/11	

T<sub>J</sub>, T<sub>stg</sub>

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.

Operating Junction and Storage Temperature Range



COMPLIANT HALOGEN FREE Available

°C

### **STS4NF100**



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	- <b>-</b> - <b>-</b>					•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	100			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			172			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 10		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.0		3.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Osta Malta na Dusia Osuma d		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	DSS	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			Α	
Drain Course On State Desistance		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A		0.032			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$		0.033		mΩ	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5 A		20		S	
Dynamic <sup>b</sup>						•	
Input Capacitance	C <sub>iss</sub>			1900		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		150			
Reverse Transfer Capacitance	C <sub>rss</sub>			50			
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		28.5	43		
				23	35	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 8 \text{ V}, I_{D} = 5 \text{ A}$		8			
Gate-Drain Charge	Q <sub>gd</sub>			6.5			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.80	1.3	Ω	
Turn-on Delay Time	t <sub>d(on)</sub>			14	21	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 10 $\Omega$		12	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	${ m I}_{ m D}\cong$ 5 A, ${ m V}_{ m GEN}$ = 10 V, ${ m R}_{ m g}$ = 1 $\Omega$		22	33		
Fall Time	t <sub>f</sub>			6	10		
Turn-On Delay Time	t <sub>d(on)</sub>			16	24	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 10 $\Omega$		12	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, \text{ V}_{\text{GEN}} = 8 \text{ V}, \text{ R}_g = 1 \Omega$		20	30		
Fall Time	t <sub>f</sub>			7	12		
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			7.7	^	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2.6 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			63	95	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$L = 5.0  dt/dt = 100.0 / u_{\rm c} = 25.0  c$		110	165	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		49			
Reverse Recovery Rise Time	t <sub>b</sub>			14		ns	

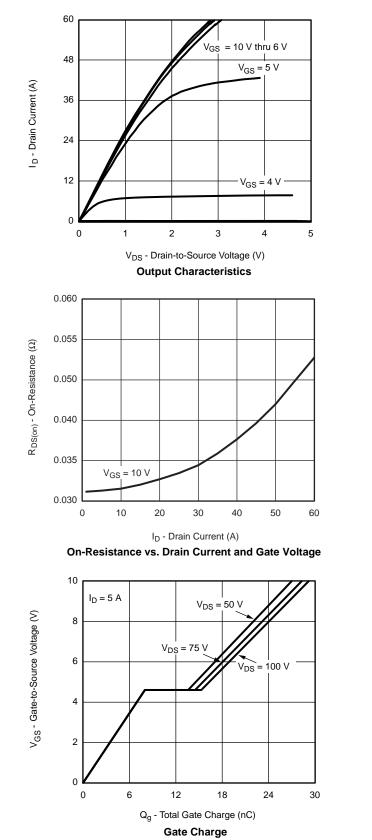
Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

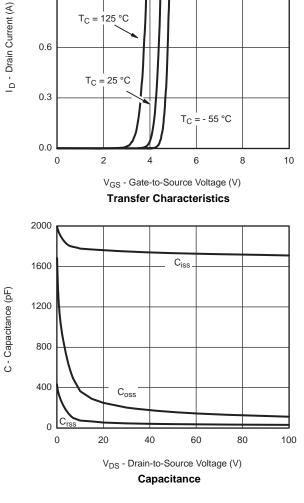
a. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

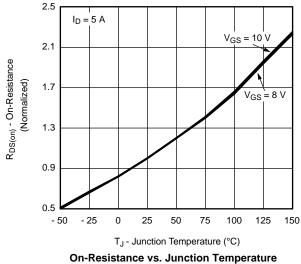


1.2

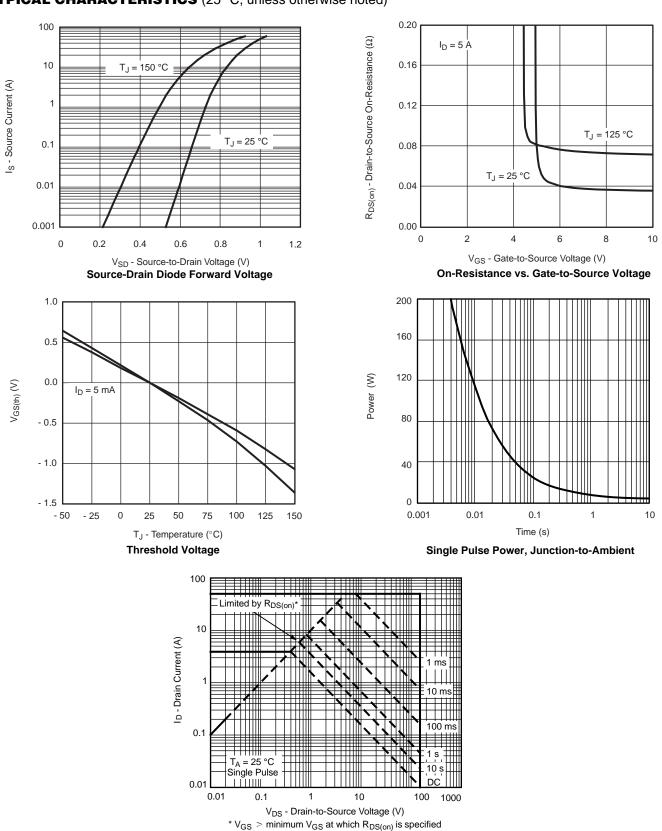
0.9

0.6

T<sub>C</sub> = 125 °C







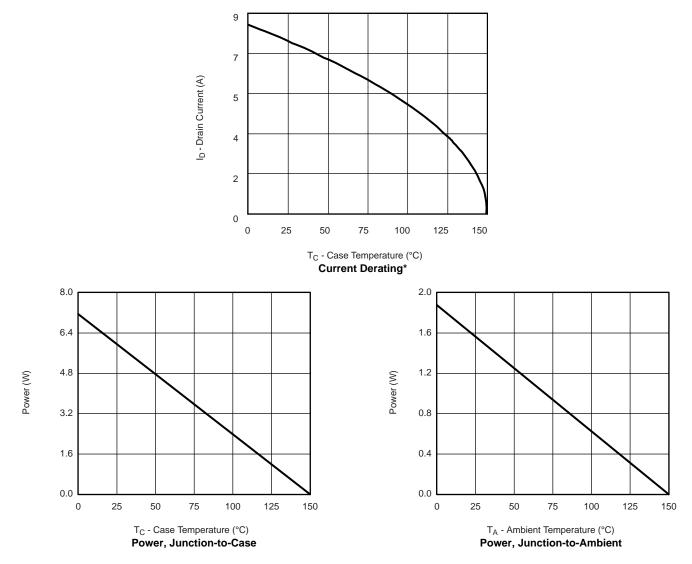
Safe Operating Area, Junction-to-Ambient

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

服务热线:400-655-8788



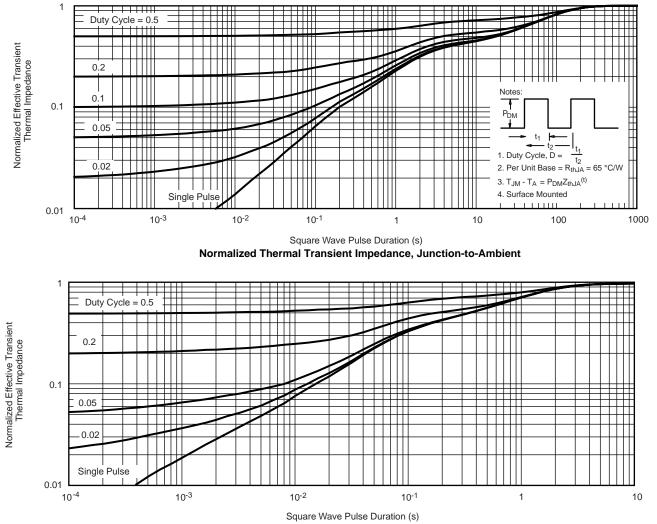
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



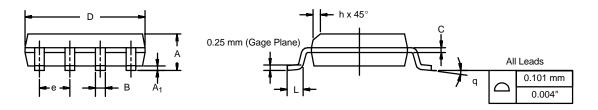
Normalized Thermal Transient Impedance, Junction-to-Foot



#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

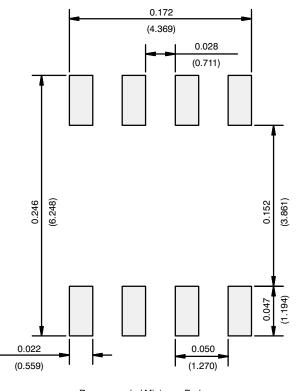




	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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